Displaytech Ltd.
a seacomp company

LCD Module
Product Specification

Product: 64128KX Series LCD Module (128 x 64 DOTS)

PRODUCT SPECIFICATIONS

- GENERAL SPECIFICATION
- ABSOLUTE MAXIMUM RATINGS
- ELECTRICAL CHARACTERISTICS
- ELECTRO-OPTICAL CHARACTERISTICS
- BLOCK DIAGRAM
- MECHANICAL DRAWING
- BACKLIGHT DRAWING
- BACKLIGHT SPECIFICATION
- QUALITY GUARANTEE
- PRECAUTIONS FOR USING LCD MODULES
- USING LCD MODULES
- REVISION RECORD

10 June 2008.

■ GENERAL SPECIFICATION

Item	Contents
Display Format	128 x 64 DOTS
Dot Size (W x H)	0.33mm x 0.33mm
View Area (W x H)	50.00mm x 25.00mm
Module Size (W x H x T)	58.20mm x 41.70mm x 8.50mm
LCD Type	FSTN
Polarizer Mode	Transflective
View Angle	6 o'clock / 12 o'clock
Backlight	LED
Backlight Driver Type	External Power
Backlight Color	White
Controller & LCD Driver	ST7565R-G
Driving Method	1/65 Duty, 1/9 Bias

Remark: Recommended mating connector:
- Molex 0524372872, 0528932895, or
- Hirose FH12-28S-0.5SH(55), FH28D-28S-0.5SH(05)

■ ABSOLUTE MAXIMUN RATINGS (Ta=25°C VSS=0V)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Power Supply for Logic	VDD-VSS	-0.3	---	3.6	V
Power Supply for LCD	V0-VSS	-0.3	---	13.5	V
Input Voltage	VIN	-0.3	---	VDD+0.3	V
Supply Voltage for LED Backlight	V_{LED}	---	3.2	---	V
Normal Operating Temperature	Top	0	---	50	°C
Normal Storage Temperature	Tst	-10	---	60	°C
Wide Operating Temperature	Top	-20	---	70	°C
Wide Storage Temperature	Tst	-30	---	80	°C

■ ELECTRICAL CHARACTERISTICS (Ta=25°C, VDD=3.0V)

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Power Supply for LCM	VDD-VSS	---	2.85	3.0	3.15	Volt
Input Voltage	VIL	L level	Vss	---	0.2VDD	Volt
	VIH	H level	0.8VDD	---	VDD	Volt
LCD Module Driving Voltage	VO-VSS	---	---	---	---	Volt
		25°C	---	9.0	---	
		---	---	---	---	
Supply Current for LCM	IDD	VDD=3.0V	---	0.5	---	mA
	Ie	---	---	---	---	
	ILED	VLED=3.2V	---	60	---	

■ ELECTRO-OPTICAL CHARACTERISTICS

NO	Item	Symbol	Measuring Condition	STD.Value				Unit	Remark
				°C	Min	Typ	Max		
1	Recommended Operating Voltage	VLCD	$\theta = 0$ $\Phi = 0$	25	---	9.0	---	V	Note1 Note2
2	Operating Voltage	Vth	$\theta = 0$ $\Phi = 0$	0	---	---	---		
				25	---	9.0	---		
				40	---	---	---		
		Vsat	$\theta = 0$ $\Phi = 0$	0	---	---	---		
				25	---	---	---		
				40	---	---	---		
3	Response time	Tr	$\theta = 0$ $\Phi = 10$	0	---	---	---	ms	Note4
				25	---	218	268		
				40	---	---	---		
		Tf	$\theta = 0$ $\Phi = 10$	0	---	---	---		
				25	---	115	165		
				40	---	---	---		
4	Viewing Angle (Cr 2)	θ	$\Phi=0°$	25	-10	10	40	Deg	Note1
		θ	$\Phi=180°$	25	30	10	---		
		θ	$\Phi=90°$	25	30	---	---		
		θ	$\Phi=270°$	25	---	---	---		
5	Current Consumption	ILCD	Hz=64	25	---	82	---	uA	Note3

**NOTE 1:　DEFINITION OF VIEWING ANGLE AND DIRECTION**
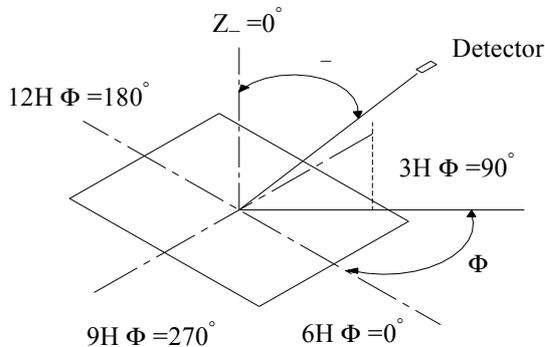
NOTE 2:　THERSHOLD VOLTAGE AND SATURATION VOLTAGE
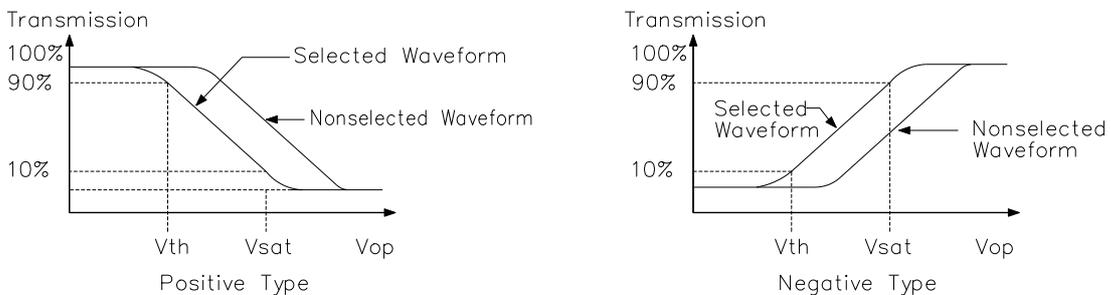
Vth: The voltage Vop which the transmission rate of segment is 90%(positive) or 10%(negative) of saturated value on conditions of the selected waveform. (non-selected waveform is opposition)

Vsat: The voltage Vop which the transmission rate of segment is 10%(positive) or 10%(negative) of saturated value on conditions of the selected waveform. (non-selected waveform is opposition)
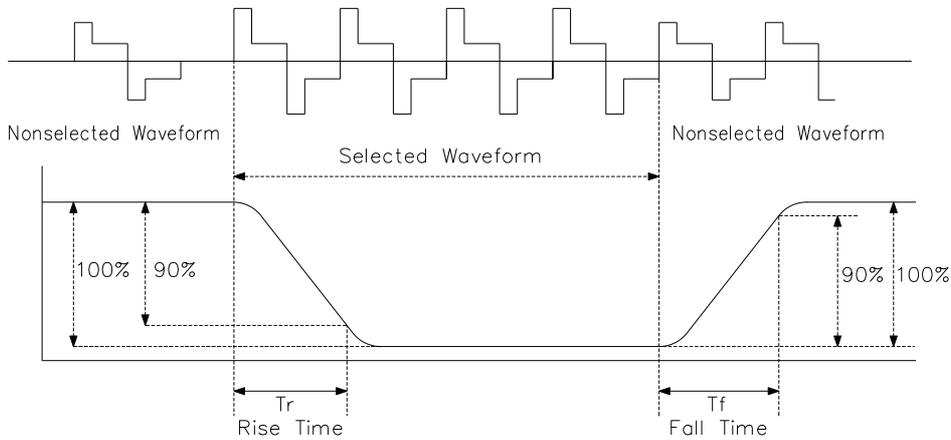
NOTE 3:   CURRENT CONSUMPTION (I$_{LCD}$)
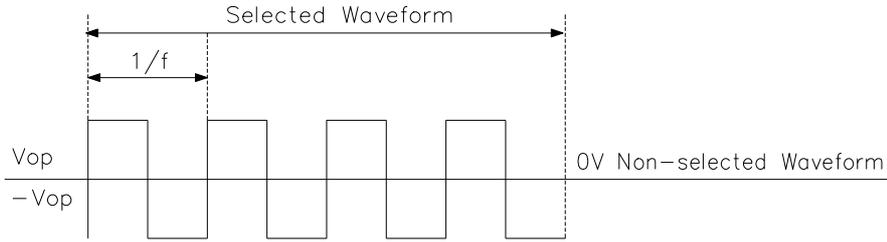
Conditions:

1.Driving waveform: static waveform.   2.Voltage applied to all segments

NOTE 4:   RESPONSE TIME (Tr, Tf)

NOTE 5:   CONTRAST RATIO (CR)

5.1   POSITIVE TYPE:

$$\text{CONTRAST RATIO} = \frac{\text{BRIGHTNESS AT VOP (NON-SELECTED)}}{\text{BRIGHTNESS AT VOP (SELECTED)}}$$

5.2   NEGATIVE TYPE:

$$\text{CONTRAST RATIO} = \frac{\text{BRIGHTNESS AT VOP (SELECTED)}}{\text{BRIGHTNESS AT VOP (NON-SELECTED)}}$$
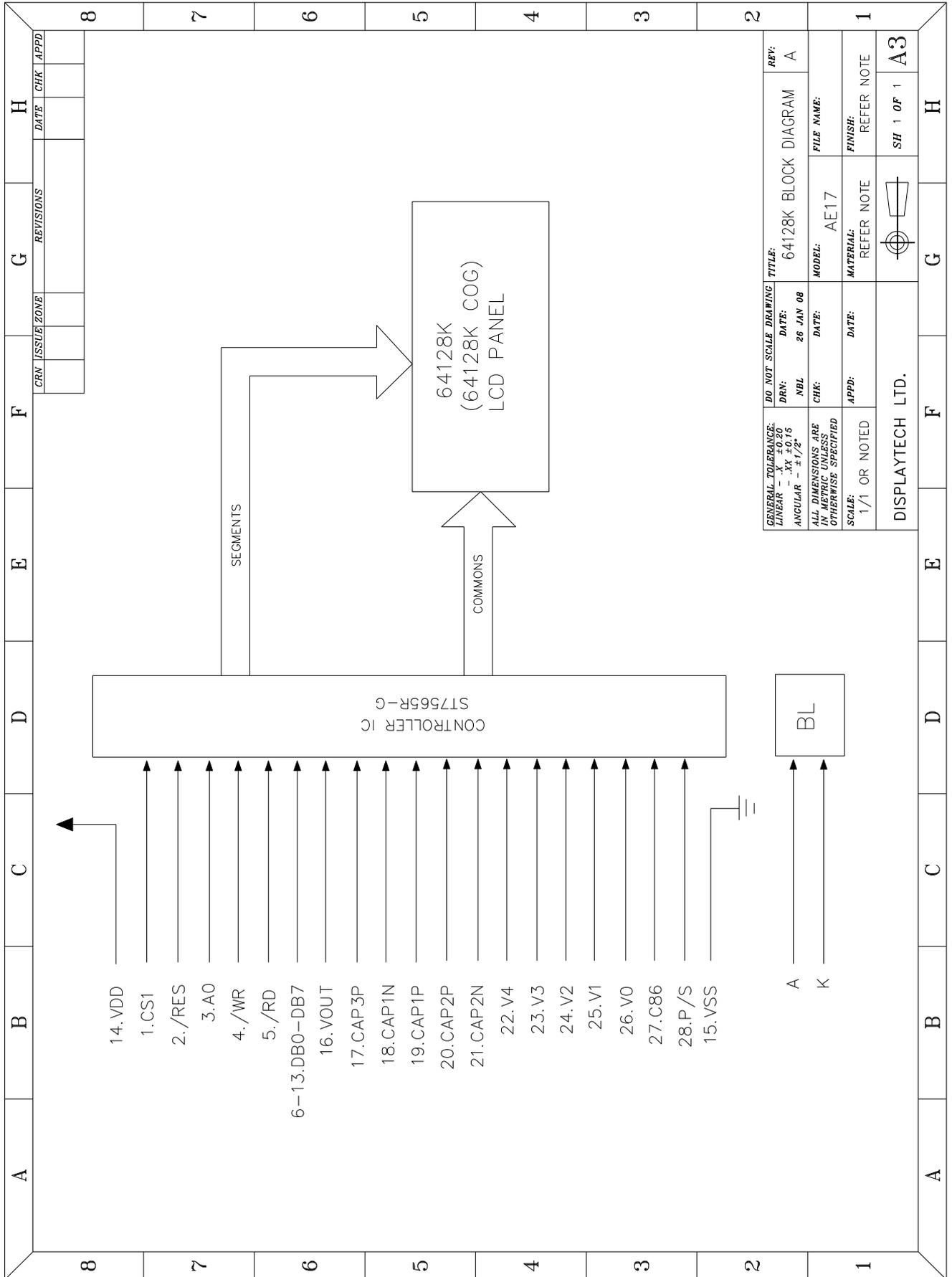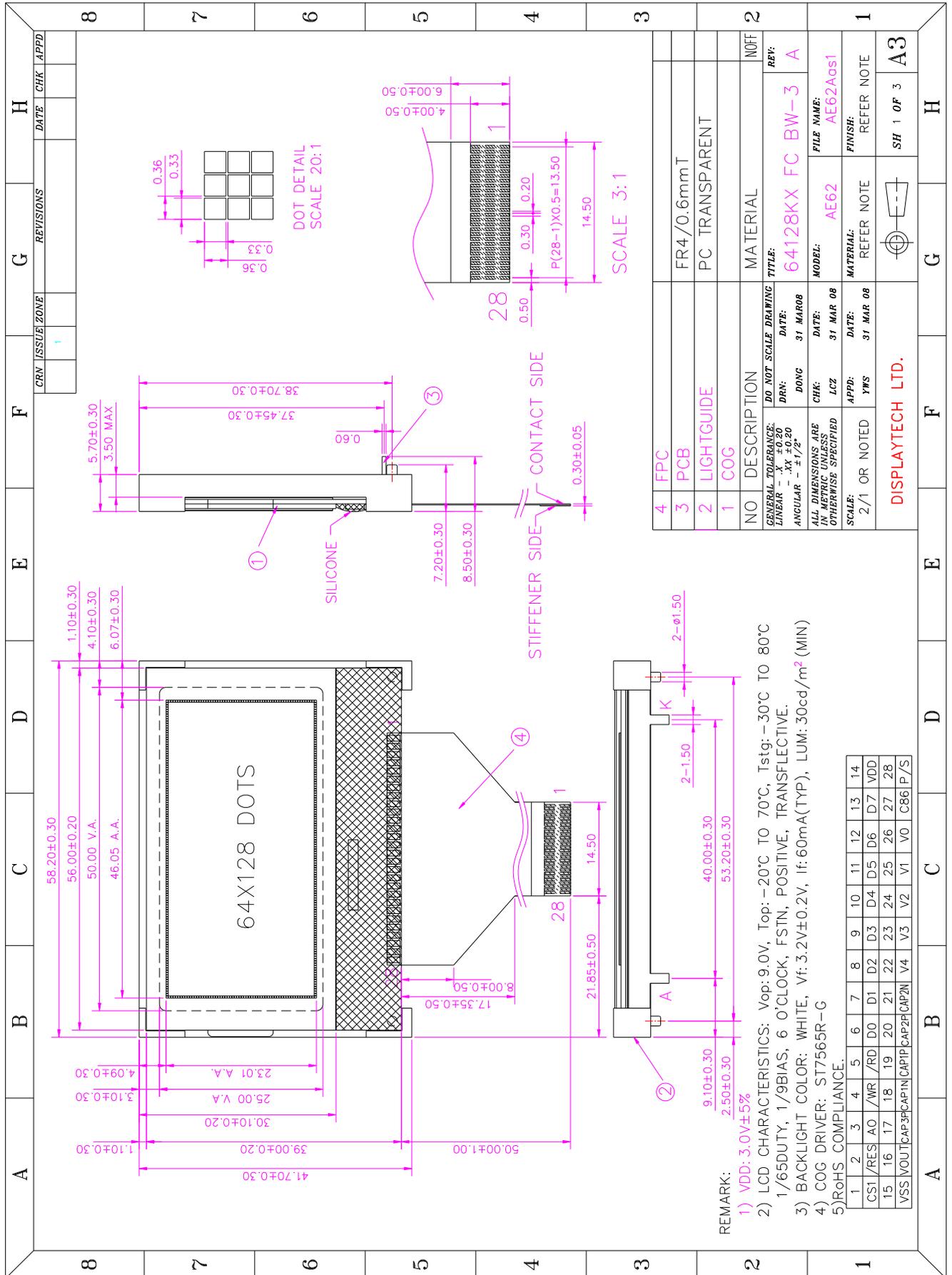
NOTE 6:   CAPACITANCE (C)

Conditions:

Voltage applied to all segments.

■ BLOCK DIAGRAM

■ MECHANCIAL DRAWING

Display: 64X128 DOTS

DOT DETAIL SCALE 20:1 — 0.36, 0.33, 0.33, 0.36

SCALE 3:1 — 6.00±0.50, 4.00±0.50, P(28-1)X0.5=13.50, 14.50, 0.20, 0.30, 0.30, 0.50, 28

Dimensions:
- 58.20±0.30
- 56.00±0.20
- 50.00 V.A.
- 46.05 A.A.
- 1.10±0.30
- 4.10±0.30
- 6.07±0.30
- 5.70±0.30
- 3.50 MAX
- 38.70±0.30
- 37.45±0.30
- 0.60
- 7.20±0.30
- 8.50±0.30
- 0.30±0.05
- 23.01 A.A.
- 25.00 V.A.
- 30.10±0.20
- 3.10±0.30
- 4.09±0.30
- 39.00±0.20
- 41.70±0.30
- 1.10±0.30
- 50.00±1.00
- 9.10±0.30
- 2.50±0.30
- 17.35±0.50
- 8.00±0.50
- 21.85±0.50
- 14.50
- 28
- 40.00±0.30
- 53.20±0.30
- 2-Φ1.50
- 2-1.50

STIFFENER SIDE — CONTACT SIDE

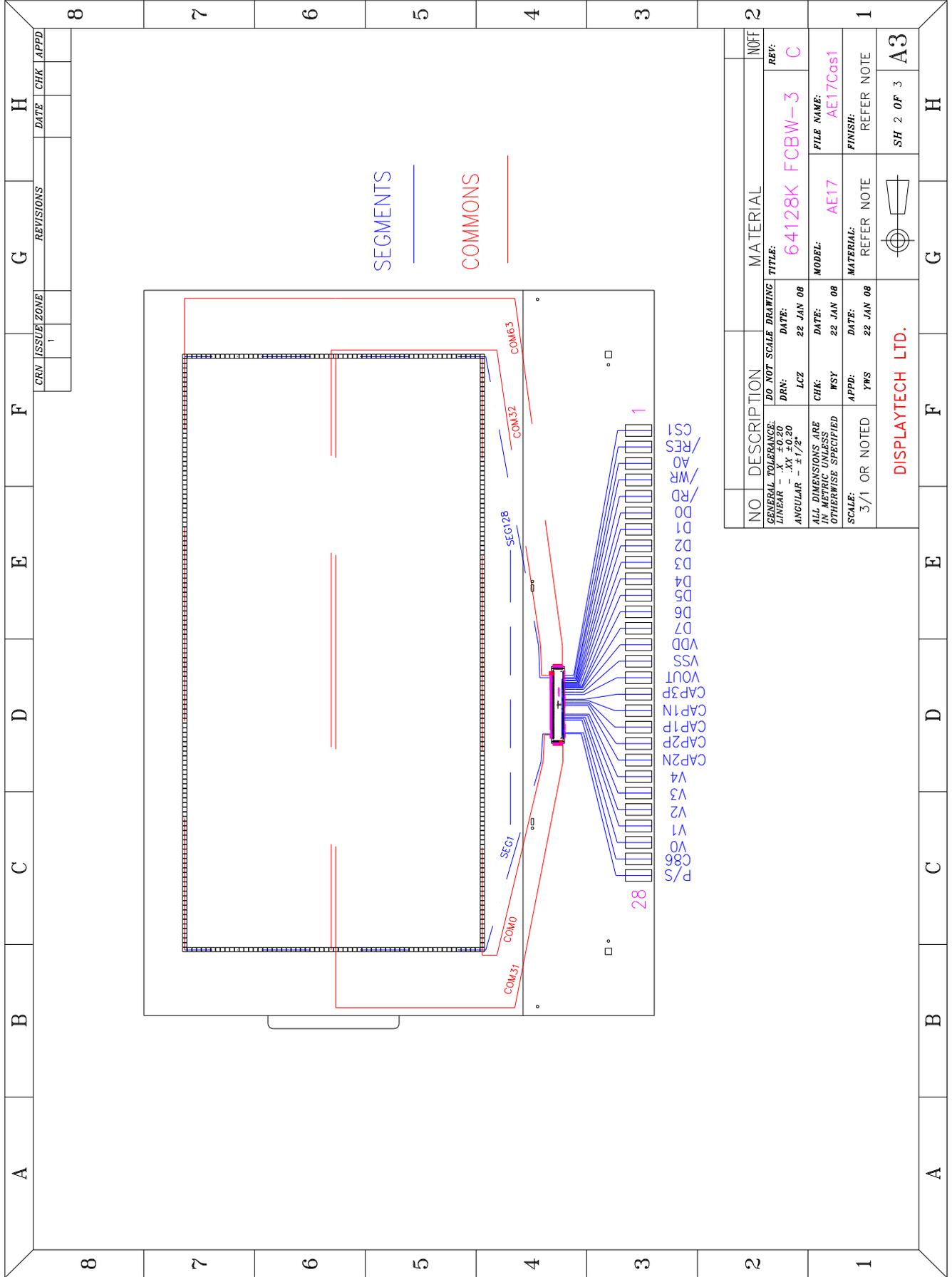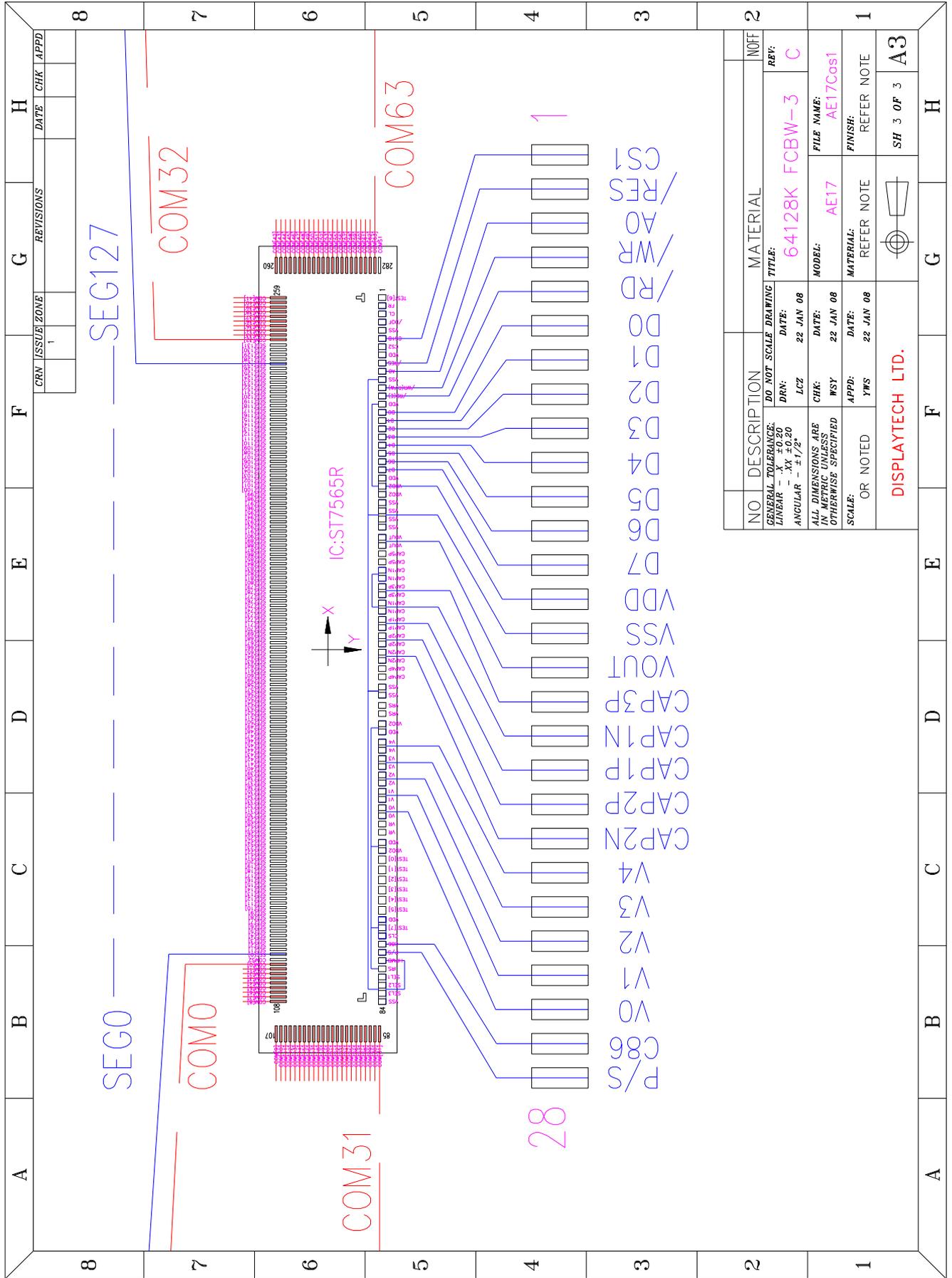SILICONE

REMARK:
1) VDD: 3.0V±5%
2) LCD CHARACTERISTICS: Vop: 9.0V, Top: -20°C TO 70°C, Tstg: -30°C TO 80°C
   1/65DUTY, 1/9BIAS, 6 O'CLOCK, FSTN, POSITIVE, TRANSFLECTIVE.
3) BACKLIGHT COLOR: WHITE, Vf: 3.2V±0.2V, If: 60mA(TYP), LUM: 30cd/m² (MIN)
4) COG DRIVER: ST7565R-G
5) RoHS COMPLIANCE.

Pin table:

1	2	3	4	5	6	7	8	9	10	11	12	13	14
CS1	/RES	A0	/WR	/RD	D0	D1	D2	D3	D4	D5	D6	D7	VDD
15	16	17	18	19	20	21	22	23	24	25	26	27	28
VSS	VOUT	CAP3P	CAP1N	CAP1P	CAP2P	CAP2N	V4	V3	V2	V1	V0	C86	P/S

Title block:

REVISIONS					
CRN	ISSUE	ZONE	DATE	CHK	APPD

NO	DESCRIPTION	MATERIAL
4	FPC	
3	PCB	FR4/0.6mmT
2	LIGHTGUIDE	PC TRANSPARENT
1	COG	

GENERAL TOLERANCE:
LINEAR - .X ±0.20
- .XX ±0.20
ANGULAR - ±1/2°

ALL DIMENSIONS ARE IN METRIC UNLESS OTHERWISE SPECIFIED

	DATE:	
DRN: DONG	31 MAR08	
CHK: LCZ	31 MAR 08	
APPD: YWS	31 MAR 08	

SCALE: 2/1 OR NOTED

DISPLAYTECH LTD.

TITLE: 64128KX FC BW-3
MODEL: AE62
MATERIAL: REFER NOTE
FINISH: REFER NOTE

REV: A
FILE NAME: AE62Aos1

SH 1 OF 3

A3

SEGMENTS

COMMONS

COM63

COM32

SEG128

COM0

SEG1

COM31

28

1

CS1
/RES
A0
/WR
/RD
D0
D1
D2
D3
D4
D5
D6
D7
VDD
VSS
VOUT
CAP3P
CAP1N
CAP1P
CAP2P
CAP2N
V4
V3
V2
V1
V0
C86
P/S

NO	DESCRIPTION			

MATERIAL

DO NOT SCALE DRAWING

DRN: LCZ	DATE: 22 JAN 08	
CHK: WSY	DATE: 22 JAN 08	
APPD: YWS	DATE: 22 JAN 08	

GENERAL TOLERANCE:
LINEAR − .X ±0.20
        .XX ±0.20
ANGULAR − ±1/2°

ALL DIMENSIONS ARE
IN METRIC UNLESS
OTHERWISE SPECIFIED

SCALE: 3/1 OR NOTED

TITLE: 64128K FCBW−3

MODEL: AE17

MATERIAL: REFER NOTE

FINISH: REFER NOTE

REV: C

FILE NAME: AE17Cqs1

NOFF

DISPLAYTECH LTD.

SH 2 OF 3

A3

IC:ST7565R

SEG127

SEG0

COM32

COM0

COM63

COM31

CS1
/RES
A0
/WR
/RD
D0
D1
D2
D3
D4
D5
D6
D7
VDD
VSS
VOUT
CAP3P
CAP1N
CAP1P
CAP2P
CAP2N
V4
V3
V2
V1
V0
C86
P/S

1

28

REVISIONS

CRN ISSUE ZONE   DATE CHK APPD

■ BACKLIGHT DRAWING

CIRCUIT DIAGRAM:

A+ —

K —

REMARK:

1) COLOR: WHITE.
NO. OF SMT LED : 3.
Vf:3.2V±0.2V, If:60mA(TYP).
2) MUST BE COMPLY WITH RoHS STANDARD.

NO	DESCRIPTION
4	DIFFUSER
3	REFLECTOR
2	LEN
1	PCB

MATERIAL
PC/TRANSPARENT
FR4/0.6mmT

TITLE:
64128G BL-3 BACKLIGHT

MODEL: T390W

FILE NAME: T390WAas1

FINISH: REFER NOTE

MATERIAL: REFER NOTE

REV: A

DISPLAYTECH LTD

GENERAL TOLERANCE:
LINEAR - .X ±0.20
ANGULAR - .XX ±0.20
ANGULAR - ±1/2°

ALL DIMENSIONS ARE IN METRIC UNLESS OTHERWISE SPECIFIED

DO NOT SCALE DRAWING

DRN: WJC   DATE: 31 OCT 05
CHK: DATE:
APPD: DATE:

SCALE: 2/1 OR NOTED

SH 1 OF 1

A3

REVISIONS

CRN	ISSUE	ZONE		DATE	CHK	APPD

38.70
37.45
0.60
3.50 Max

② DIFFUSER ④

58.20
56.20
52.00 V.A
49.20
1.00
3.10
4.50

27.70
27.00 V.A
12.60
7.00
39.20
1.50
41.70

REFLECTOR ③

2-R0.20
2-Ø1.50
K
40.00
53.20
①
REFLECTOR ③
2-1.50
9.10
A
2.50
5.70
7.20
8.50

■ BACKLIGHT SPECIFICATION

◆ MECHANICAL SPECIFICATIONS

ITEM	NOMINAL DIMENSIONS	UNIT
OUTLINE SIZE (LxWxH)	58.20 x 41.70 x 8.50	mm
VIEWING AREA (LxW)	52.0 x 27.0	mm
CONTACT PIN PITCH/LENGTH	NIL	mm
NO.OF LED SMT	3	---

◆ ELECTRICAL/OPTICAL CHARACTERISTICS (Ta=25˙C, If=60mA typ.)

MODE	PARAMETER		UNIT
COLOR	WHITE		---
CHROMATICITY COORDINATE	X=0.2993	Y=0.3126	---
AVERAGE LUMINOUS INTENSITY (IV)	250 typ.		cd/m^2
FORWARD VOLTAGE (Vf)	3.2 typ.		V

◆ ABSOLUTE MAXIMUM RATING

ITEM	VALUE	UNIT
FORWARD CURRENT	90mA	If
REVERSE VOLTAGE	5V	Vr
POWER DISSIPATION	288mW	Pd
OPERATING TEMPERATURE	-20°C TO 70°C	Top
STORAGE TEMPERATURE	-30°C TO 80°C	Tstg
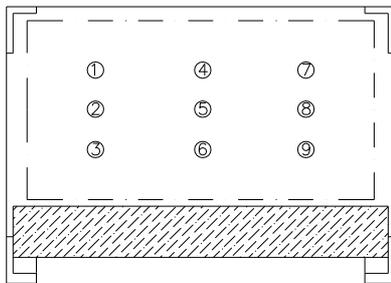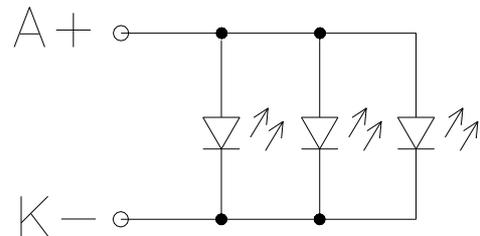
TESTING POINT   **CIRCUIT DIAGRAM**

REMARK:
1. **AVERAGE LUMINOUS INTENSITY IS THE AVERAGE VALUE OF THE NINE INDICATED POINTS AS SHOWN**.
2. **MEASUREMENT INSTRUMENT: BM-7, APERTURE: ˙10mm.**

■ QUALITY GUARANTEE

◆ PURPOSE: It is to define the inspection standard of LCD modules

◆ PRODUCT STANDARD

1) INSPECTION AND TEST
- FUNCTION TEST
- APPEARANCE INSPECTION
- PACKING SPECIFICTION

2) INSPECTION CONDITION
- Put under the lamp (20w×2) at a distance 100mm from the LCD Modules.
- Tilt upright 45 degree by the front (back) to inspect LCD appearance.

3) AQL INSPECTION LEVEL
- SAMPLING METHOD : MIL-STD-105D
- SAMPLING PLAN   : SINGLE
- MAJOR DEFECT   : 0.65%   (MAJOR)
- MINOR DEFECT   : 2.5%   (MINOR)
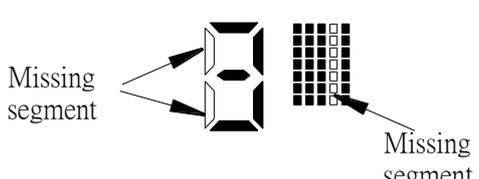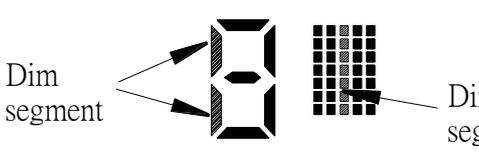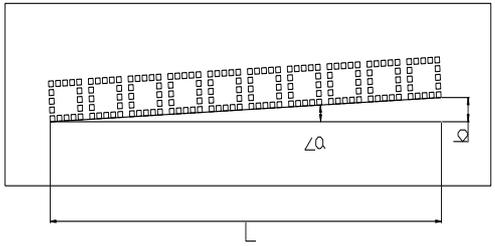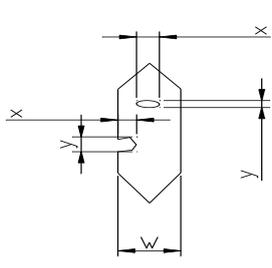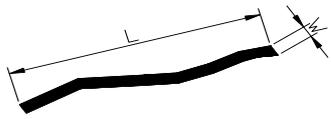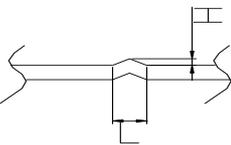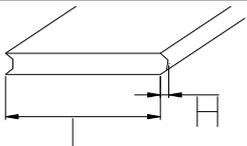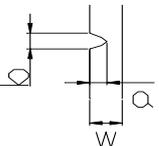- GENERAL LEVEL   : II/NORMAL
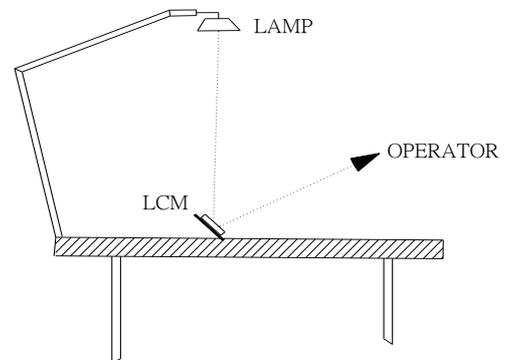
◆ DISPLAY AREA DEFINITION:
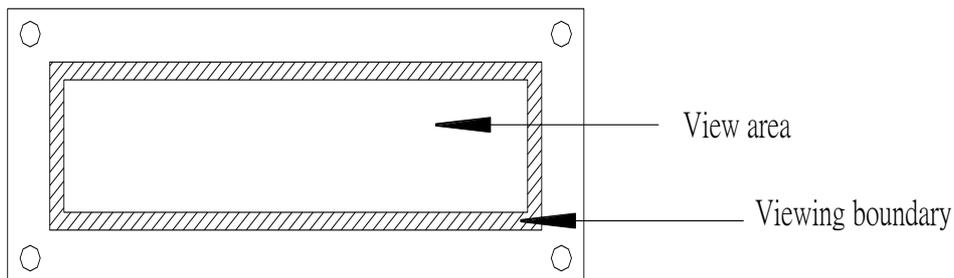
◆ **INSPECTION STANDARD**

1) FUNCTIONAL TEST STANDARD

Item	Inspection Standard Description		Standard	Defect type
1	LCD has no display		Reject	MAJ
2	LCM display do not change		Reject	MAJ
3	Display wrong pattern		Reject	MAJ
4	Display segment open	Missing segment Missing segment	Reject	MAJ
5	Display dim segment	Dim segment Dim segment	Reject	MAJ
6	Wrong LCD viewing direction		Reject	MAJ
7	Dim Display		See sample	MAJ
8	LCD color variation		See sample	MAJ

9	Pattern parallelism	Acceptable range				
		L	<a	b		
		≧20mm	│0.43°│	≦0.15mm	Accept	
		≧30mm	│0.38°│	≦0.2mm		
		≧40mm	│0.43°│	≦0.3mm		
		≧50mm	│0.40°│	≦0.35mm		
		≧60mm	│0.43°│	≦0.45mm		
		≧70mm	│0.41°│	≦0.50mm		
		≧80mm	│0.43°│	≦0.60mm		
		≧90mm	│0.41°│	≦0.65mm		
		≧100mm	│0.43°│	≦0.75mm		

10	LCD display Pin hole		Standard			
			$\varnothing = \dfrac{x + y}{2}$	QTY		
			$\varnothing \leq 0.25$	1	Accept	
			$\varnothing > 0.25$	1	Accept	
			$\varnothing < \dfrac{1}{4} W$	1	Accept	
			$\varnothing > \dfrac{1}{4} W$	1	Reject	MIN

Item	Inspection Standard Description			Standard	Defect type
		Draw	Standard		
			X	y	QTY		
11	LCD display Broken segment(dots)		$\geqq \dfrac{1}{4} b$; $\geqq \dfrac{1}{4} a$; QTY 1	Reject	MIN
			(X or y) $\geqq 0.2$mm ; 1	Reject	MIN
			$\leqq \dfrac{1}{4} b$; $\leqq \dfrac{1}{4} a$; 1	Accept	
			$\leqq \dfrac{1}{5} b$; $\leqq \dfrac{1}{5} a$; 2	Accept	
12	LCD display Black spot or White spot		$\varnothing = \dfrac{x+y}{2}$; QTY		
			$\varnothing<0.10$;	Accept	
			$0.1<\varnothing\leqq0.20$; 2	Accept	
			$0.20\leqq\varnothing<0.25$; 1	Accept	
			$0.25<\varnothing\leqq0.4$; 0	Reject	MIN
			$\varnothing>0.4$; 0	Reject	MAJ
13	LCD display excess black line or white line	Black line/white line(L×w)mm ; QTY			
		$(L\leqq1.0)\times(W\leqq0.025)$; 2	Accept	
		$(1.0<L\leqq1.5)\times(W\leqq - \cdot 0.025)$; 1	Accept	
		$(L>1.5)\times(W\leqq0.025)$; 0	Reject	MIN
		$(L>2)\times(W>0.025)$; 0	Reject	MAJ
14	Backlight not function			Reject	MAJ
15	LED not function or dim			Reject	MIN
16	Backlight defect (dirt, scratch)			Reject	MIN

2) COSMETIC INSPECTION STANDARD

Item	Standard description of inspection			Standard	Defect type
1	**LCD inspection item**				
1.1	LCD color variation			See sample	MIN
1.2	LCD broken			Reject	MAJ
1.3	Wrong polarizer of LCD			Reject	MAJ
1.4	Spot on LCD surface			Reject	MAJ
1.5	Scratch on LCD $\varnothing = \dfrac{x+y}{2}$		Scratch = $\varnothing$; QTY		
			$\varnothing<0.1$; Except	Accept	
			$0.1\leqq\varnothing\leqq0.15$; 2	Accept	
			$0.15<\varnothing\leqq0.25$; 1	Accept	
			$\varnothing>0.25$; 1	Reject	MIN
1.6	LCD scratch Scratch depth see sample	Scratch =L ; scratch =W ; QTY			
		; $W\leqq0.015$;	Accept	
		<0.5 ; $W\leqq0.02$; 2	Accept	
		<1.0 ; $W\leqq0.03$; 1	Accept	
		$\geqq1.0$; $W\geqq0.03$; 1	Reject	MIN
1.7	White or black spot on LCD $\varnothing = \dfrac{x+y}{2}$		; QTY		
			$\varnothing<0.1$;	Accept	
			$0.1\leqq\varnothing<0.2$; 2	Accept	
			$0.2\leqq\varnothing\leqq0.25$; 1	Accept	
			$\varnothing>0.25$; 1	Reject	MIN
			Bevy point ; -	Reject	MIN

Item	Standard description of inspection					Standard	Defect type
1.8	Black line in LCD		(L)	(W)	QTY		
			L≦1.0	W≦0.025	2	Accept	
			1.0<1≦1.5	W≦0.025	1	Accept	
			1.5<L	W>0.025	1	Reject	MIN
1.9	Round air bubble		Size		QTY		
			Ø<0.15		2	Accept	
			0.15≦Ø≦0.25		1	Accept	
			Ø>0.25		0	Reject	MIN
1.10	Line defect		(L)	(W)	QTY		
			L<0.5	W<0.02	2	Accept	
			L<1.0	W<0.03	1	Accept	
			L≧1.0	W≧0.3	0	Reject	MIN
1.11	Finger print					Reject	MIN
2	**PCB/COB specification**						
2.1	PCB deformity		L	H			
			≦6.0mm	≦1.5mm		Accept	
			>6.0mm	≦1.5mm		Reject	MIN
			<6.0mm	>1.5mm		Reject	MIN
			>6.0mm	>1.5mm		Reject	MIN
2.2	Deformity at PCB edge, damage circuit.					Reject	MAJ
2.3	Convex at PCB edge		L	H			
			≦6.0mm	≦1.5mm		Accept	
			>6.0mm	≦1.5mm		Reject	MIN
			<6.0mm	>1.5mm		Reject	MIN
			>6.0mm	>1.5mm		Reject	MIN
2.4	Damage excess 2x2mm at the PCB corner					Reject	MIN
2.5	Scratch on PCB surface					See sample	MIN
2.6	Scratch on PCB coat/leakage coat on PCB surface					Reject	MAJ
2.7	Open circuit					Reject	MAJ
2.8	PCB PTH open					Reject	MAJ
2.9	Repair PCB PTH				QTY≦2PCS	Accept	
					QTY≧3PCS	Reject	MAJ
2.10	Color different from one side to another side.					Reject	MIN
2.11	Repaired solder mask area				≦30mm^2	Accept	
					≧30mm^2	Reject	MIN
2.12	Scratch circuit, damage Circuit				$a≦1/2w$ or $b<w$	Accept	
					$a>1/2w$ or $b>w$	Reject	
3	**Bezel specification**						
3.1	Wrong Materials						MAJ
3.2	Incorrect dimension						MAJ
3.3	Bezel broken						MAJ
3.4	Rust on Bezel						MAJ
3.5	Hole or dirty on oil Paint surface		Size	cm^2/per			
		Top surface	Ø≦0.3	2		Accept	
			0.3<Ø≦0.5	1		Accept	
			Ø>0.5	0		Reject	MIN
		Side	Ø≦0.5	2		Accept	
			0.5<Ø≦0.8	1		Accept	
			Ø>0.8	0		Reject	MIN

Item	Standard description of inspection			Standard	Defect type
3.6	Bezel bow or twist		$h \leqq 0.01$ mm/mm	Accept	
			$h > 0.01$ mm/mm	Reject	MIN
3.7			$d1-d2 \leqq$ tolerance	Accept	
			$d1-d2 >$ tolerance	Reject	MIN
3.8	Scratch on bezel	Face		Accept QTY	
		L	W	Not defined	
		-	$W \leqq 0.15$		
		$L \leqq 3$	$W \leqq 0.20$	2	See Sample
		$L \leqq 2$	$W \leqq 0.3$	2	
		-	$W > 0.3$		
		side		Accept QTY	
		L	W		
		-	$W \leqq 0.2$	except	See Sample
		$L \leqq 3$	$W \leqq 0.25$	2	
		$L \leqq 2$	$W \leqq 0.3$	2	
3.9	Twist angle $\alpha = 45° + 5°$			Accept	
3.10	Void gap between bezel and PCB			Reject	MIN
3.11	Bezel clip incorrectly NG			Reject	MIN
4	**Solder specification**				
4.1	Wrong component			Reject	MAJ
4.2	Broken component			Reject	MAJ
4.3	Mis-alignment	Component legs extend beyond the pad and Legs >pad distance(w) on solder area $> W^2$		Accept	
		Component legs extend beyond the pad and Legs >pad distance(w) on solder area $< W^2$		Reject	MIN
	Component Offset	Solder legs offset distance L<solder legs 1/4W		Accept	
		Solder legs offset L>1/4W		Reject	MIN
4.4	Component assembly defect			Reject	MIN
4.5	CHIP components hoist $\leqq 0.5$mm			Accept	
4.6	CHIP components hoist > 0.5mm			Reject	MIN
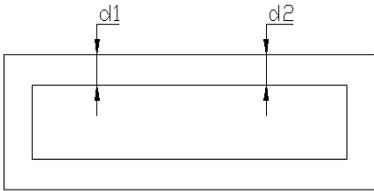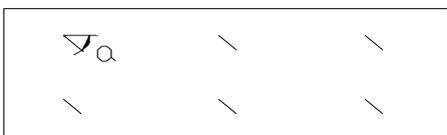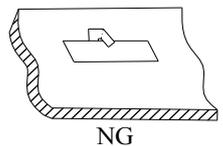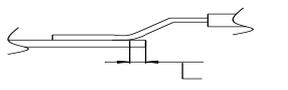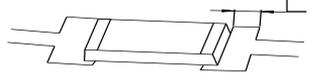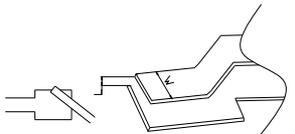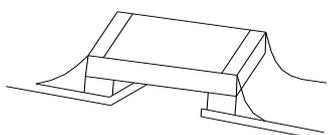
Item	Standard description of inspection		Standard	Defect type
4.7	Components hoist	h≦2.0mm	Accept	
		h>2.0mm	Reject	MIN
4.8	Switch (socket) hoist	h≦0.5mm	Accept	
		h>0.5mm	Reject	MIN
4.9	Components cold solder or incomplete solder		Reject	MAJ
4.10	Solder PAD tilt up, but height (h) less than Solder PAD thickness (a)		Accept	
4.11	Excess solder above components		Reject	Min
4.12	Insufficient solder below components height or less than diameter		Reject	MIN
4.13	Solder area less than soldering PAD Area by 2/3		Reject	MIN
4.14	Trimmed pin length beyond 0.09inch (2.3mm)		Reject	Min
5	**Packing specification**			
5.1	Wrong carton mark .		Reject	MAJ
5.2	Carton mark problem		Reject	MIN
5.3	Carton damage extend than 150mm		Reject	MAJ
5.4	Carton damage, scratch more 50mm, less 150mm.		Reject	MIN
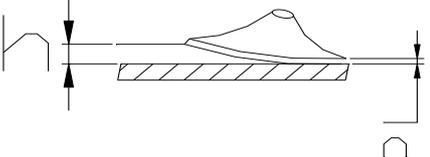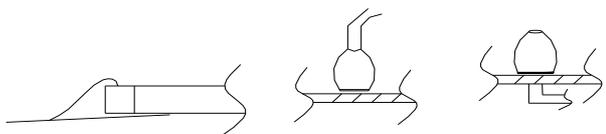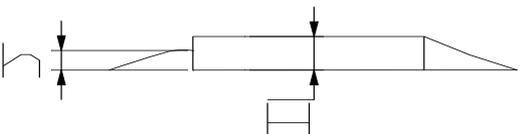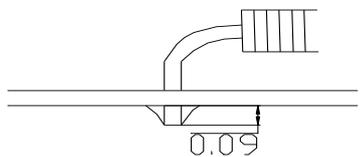
■ PRECAUTIONS FOR USING LCD MODULES

◆ HANDLING PRECAUTIONS

1. This device is susceptible to Electro-Static Discharge (ESD) damage. Observe Anti-Static precautions.
2. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
3. If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
4. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
5. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
6. If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents :
    *   Isopropyl alcohol
    *   Ethyl alcohol
7. Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
    *   Water
    *   Ketone
    *   Aromatic solvents
8. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
9. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
10. Do not attempt to disassemble or process the LCD module.
11. NC terminal should be open. Do not connect anything.
12. If the logic circuit power is off, do not apply the input signals.
13. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
    *   Be sure to ground the body when handling the LCD modules.
    *   Tools required for assembling, such as soldering irons, must be properly grounded.
    *   To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
    *   The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

◆ POWER SUPPLY PRECAUTIONS:

1. Identify and, at all times, observe absolute maximum ratings for both logic and LC drivers. Note that there is some variance between models.
2. Prevent the application of reverse polarity to VDD and VSS, however briefly.
3. Use a clean power source free from transients. Power-up conditions are occasionally "jolting" and may exceed the maximum ratings of the modules.
4. The VDD power of the module should also supply the power to all devices that may access the display. Don't allow the data bus to be driven when the logic supply to the module is turned off.

◆ OPERATING PRECAUTIONS:

1. DO NOT plug or unplug the module when the system is powered up.
2. Minimize the cable length between the module and host MPU.
3. For models with EL backlights, do not disable the backlight by interrupting the HV line. Unload inverters produce voltage extremes that may arc within a cable or at the display.
4. Operate the module within the limits of the modules temperature specifications.

◆ MECHANICAL/ENVIRONMENTAL PRECAUTIONS:

1. Improper soldering is the major cause of module difficulty. Use of flux cleaner is not recommended as they may seep under the elastomeric connection and cause display failure.
2. Mount the module so that it is free from torque and mechanical stress.
3. Surface of the LCD panel should not be touched or scratched. The display front surface is an easily scratched, plastic polarizer. Avoid contact and clean only when necessary with soft, absorbent cotton dampened with petroleum benzene.
4. Always employ anti-static procedure while handling the module.
5. Prevent moisture build-up upon the module and observe the environmental constraints for storage temperature and humidity.
6. Do not store in direct sunlight
7. If leakage of the liquid crystal material should occur, avoid contact with this material, particularly ingestion. If the body or clothing becomes contaminated by the liquid crystal material, wash thoroughly with water and soap

◆ Storage Precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags (avoid high temperature / high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

◆ Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- Terminal electrode sections.

■ USING LCD MODULES

◆ Liquid Crystal Display Modules

LCD is composed of glass and polarizer. Pay attention to the following items when handling.

1. Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
2. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
3. N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
4. When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.
5. Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
6. Avoid contacting oil and fats.
7. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
8. Do not put or attach anything on the display area to avoid leaving marks on.
9. Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
10. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

◆ Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

1. Cover the surface with a transparent protective plate to protect the polarizer and LC cell.
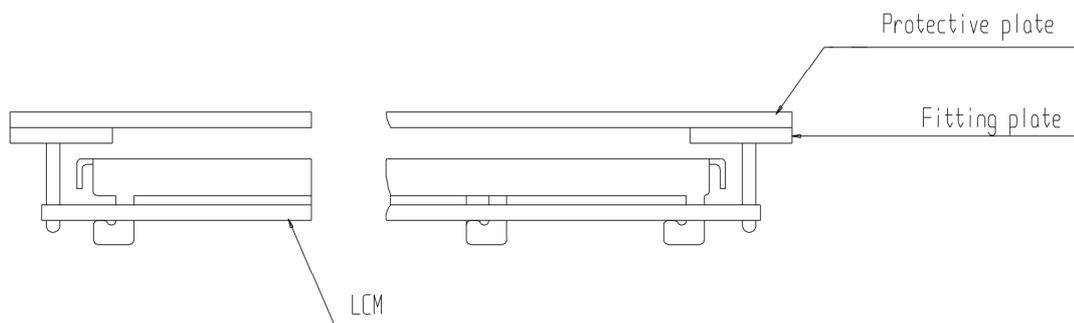
2. When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ±0.1mm.

◆ **Precaution for Handing LCD Modules**

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
1. Do not alter, modify or change the shape of the tab on the metal frame.
2. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
3. Do not damage or modify the pattern writing on the printed circuit board.
4. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
5. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
6. Do not drop, bend or twist LCM.

◆ **Electro-Static Discharge Control**

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.
1. Make certain that you are grounded when handing LCM.
2. Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
3. When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
4. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
5. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
6. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

◆ **Precaution for soldering to the LCM**

1. Observe the following when soldering lead wire, connector cable and etc. to the LCM.
   - Soldering iron temperature : 280°C ± 10°C.
   - Soldering time : 3-4 sec.
   - Solder : eutectic solder.

   If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
2. When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
3. When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

◆ **Precautions for Operation**

1. Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
2. Driving the LCD in the voltage above the limit shortens its life.
3. Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
4. If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
5. Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C , 50% RH.
6. When turning the power on, input each signal after the positive/negative voltage becomes stable.

◆ **Storage**

When storing LCDs as spares for some years, the following precaution are necessary.
1. Store them in a sealed polyethylene bag. If properly sealed, there is no need for desiccant.
2. Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
3. The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)
4. Environmental conditions :
   • Do not leave them for more than 168hrs. at 60°C.
   • Should not be left for more than 48hrs. at -20°C.

◆ **Safety**

1. It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
2. If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

◆ **Limited Warranty**

Unless agreed between DISPLAYTECH and customer, DISPLAYTECH will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with DISPLAYTECH LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to DISPLAYTECH within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DISPLAYTECH limited to repair and/or replacement on the terms set forth above. DISPLAYTECH will not be responsible for any subsequent or consequential events.

◆ **Return LCM under warranty**

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
   • Broken LCD glass.
   • PCB eyelet's damaged or modified.
   • PCB conductors damaged.
   • Circuit modified in any way, including addition of components.
   • PCB tampered with by grinding, engraving or painting varnish.
   • soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.

■ **REVISION RECORD**

VERSION	CHANGES	DATE
1.0	Initial revision	10 June 2008